



## N-Channel Super Junction Power MOSFET III

## **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

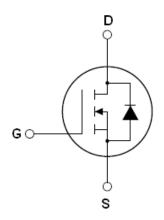
#### **Features**

- New technology for high voltage device
- Low on-resistance and low conduction losses
- ●Small package
- Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

#### **Application**

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V <sub>DS</sub>	650	V
R <sub>DS(ON)TYP</sub>	460	mΩ
$I_D$	8	A



Schematic diagram

### **Package Marking And Ordering Information**

Device	Device Package	Marking
NCE65T540I	TO-251	NCE65T540I
NCE65T540K	TO-252	NCE65T540K





TO-251

TO-252

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Table 1. Absolute Maximum Ratings (T<sub>c</sub>=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGS=0V)	V <sub>DS</sub>	650	V
Gate-Source Voltage (V <sub>DS</sub> =0V) ,AC (f>1 Hz)	V <sub>GS</sub>	±30	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	8	А
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	5.2	А
Pulsed drain current (Note 1)	I <sub>DM (pluse)</sub>	32	А
Maximum Power Dissipation(Tc=25℃)	P <sub>D</sub>	69	W
Derate above 25°C		0.55	w/°C
Single pulse avalanche energy (Note2)	Eas	156	mJ
Avalanche current <sup>(Note 1)</sup>	I <sub>AR</sub>	1.7	А
Repetitive Avalanche energy , $t_{AR}$ limited by $T_{jmax}$ (Note 1)	E <sub>AR</sub>	0.3	mJ
Parameter	Symbol	Value	Unit



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Drain Source voltage slope, V <sub>DS</sub> ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS} \le 480 \text{ V,I}_{SD} < I_D$	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55+150	°C

#### **Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	$R_{thJC}$	1.81	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	$R_{thJA}$	62	°C /W

Table 3. Electrical Characteristics (TA=25℃unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states			1	176	1110421	
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			100	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	3		4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =4A		460	540	mΩ
Dynamic Characteristics			1			
Input Capacitance	C <sub>iss</sub>	.,		590		pF
Output Capacitance	Coss	$V_{DS}$ =50V, $V_{GS}$ =0V,		37		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		0.9		pF
Total Gate Charge	$Q_g$	1/ 1001/1 01		14.6	22	nC
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> =480V,I <sub>D</sub> =8A,		4		nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V		6.7		nC
Switching times					I.	
Turn-on Delay Time	t <sub>d(on)</sub>			8		nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =380 $V$ , $I_{D}$ =4 $A$ ,		6		nS
Turn-Off Delay Time	$t_{d(off)}$	$R_G$ =4.7 $\Omega$ , $V_{GS}$ =10 $V$		59	75	nS
Turn-Off Fall Time	t <sub>f</sub>			10	15	nS
Source- Drain Diode Characteristics					I.	
Source-drain current(Body Diode)	I <sub>SD</sub>	T 0500			8	Α
Pulsed Source-drain current(Body Diode)	I <sub>SDM</sub>	T <sub>C</sub> =25°C			32	Α
Forward On Voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =8A,V <sub>GS</sub> =0V		0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			230		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I <sub>F</sub> =4A,di/dt=100A/µs		1.2		uC
Peak Reverse Recovery Current	I <sub>rrm</sub>			10.5		Α

Notes: 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R\_G=25 $\Omega$ 



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

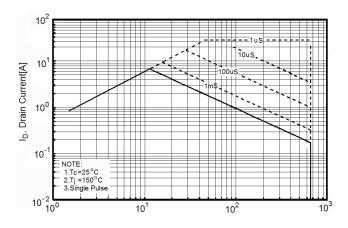


Figure 3. Source-Drain Diode Forward Voltage

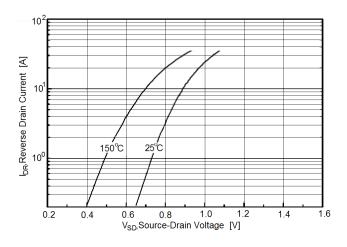


Figure 5. Transfer characteristics

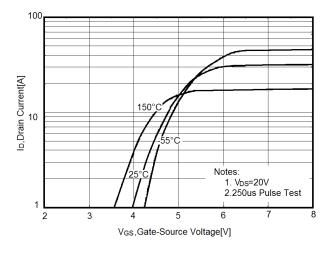


Figure 7. R<sub>DS(ON)</sub> vs Junction Temperature

Figure 2. Transient Thermal Impedance

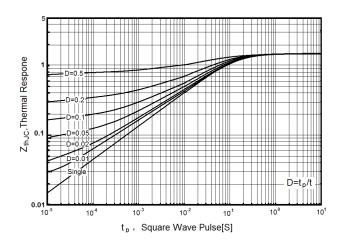


Figure 4. Output characteristics

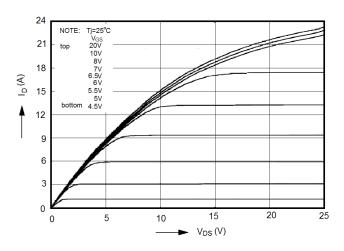


Figure 6. Static drain-source on resistance

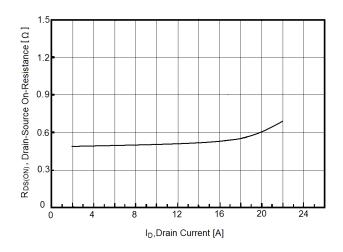
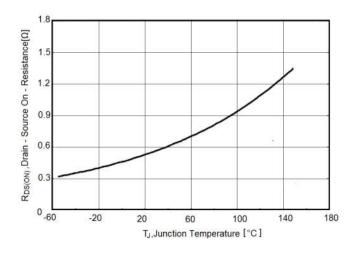


Figure8. BV<sub>DSS</sub> vs Junction Temperature

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# NCE65T540I, NCE65T540K



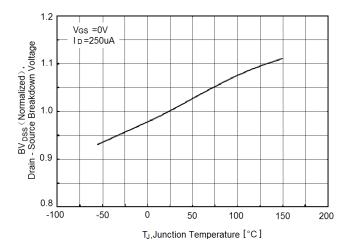


Figure 9. Maximum I<sub>D</sub> vs Junction Temperature

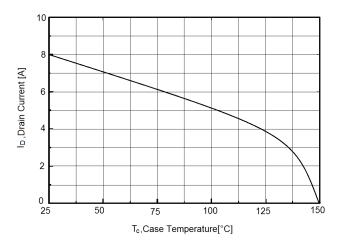


Figure 10. Capacitance

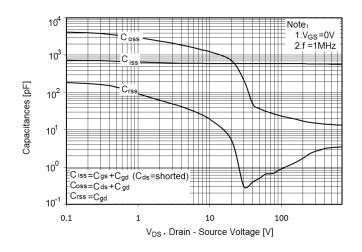
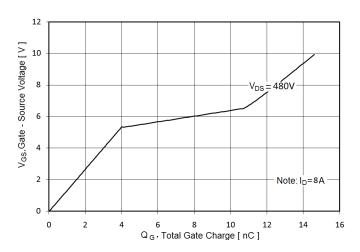


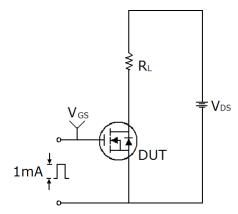
Figure 11. Gate charge waveforms

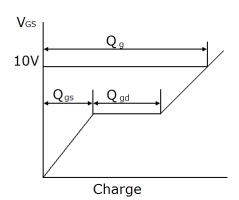




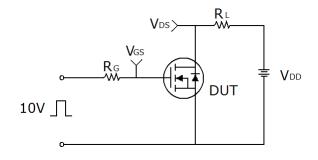
## **Test circuit**

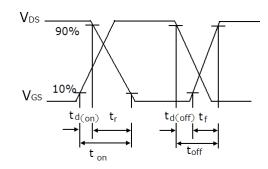
#### 1) Gate charge test circuit & Waveform



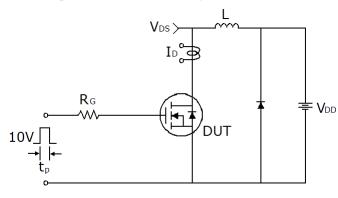


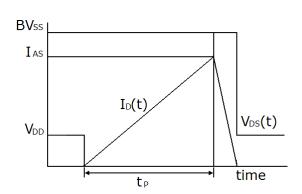
#### 2) Switch Time Test Circuit:





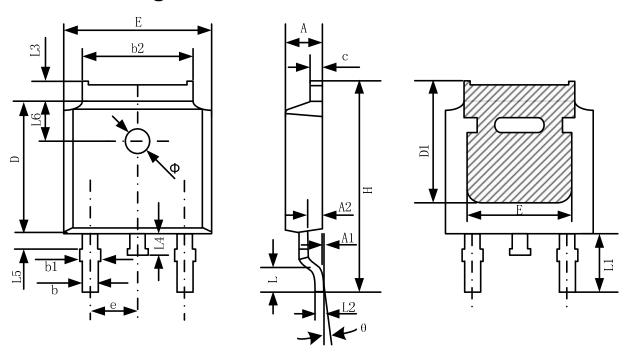
## 3) Unclamped Inductive Switching Test Circuit & Waveforms







# **TO-252-2 Package Information**

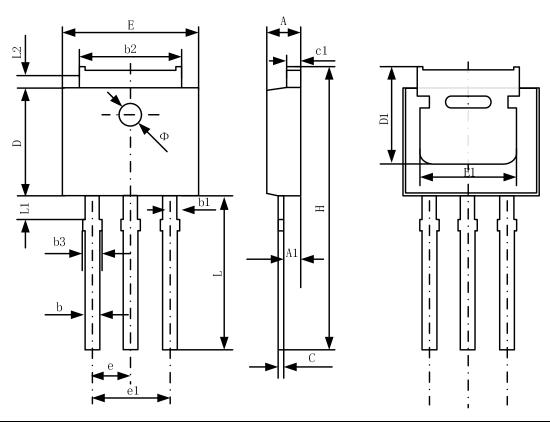


Compleal	Dimension	s In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	2.20	2.38	0.087	0.094	
A1	0.00	0.10	0.000	0.004	
A2	0.90	1.10	0.035	0.043	
b	0.72	0.85	0.028	0.033	
b1	0.72	0.90	0.028	0.035	
b2	5.13	5.46	0.202	0.215	
С	0.47	0.60	0.019	0.024	
D	6.00	6.20	0.236	0.244	
D1	5.25		0.207		
Е	6.50	6.70	0.256	0.264	
E1	4.70		0.185		
e	2.19	2.39	0.086	0.094	
Н	9.80	10.40	0.386	0.409	
L	1.40	1.70	0.055	0.067	
L1	2.9	00 REF	0.114 REF		
L2	0.5	08 BSC	0.020 BSC		
L3	0.90	1.25	0.035	0.049	
L4	0.60	1.00	0.024	0.039	
L5	0.15	0.75	0.006	0.030	
L6	1.80 REF		0.071 REF		
Ф	1.20	1.40	0.047	0.055	
θ	0°	8°	0°	8°	

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# **TO-251 Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.20	2.35	0.087	0.093	
A1	0.90	1.10	0.035	0.043	
b	0.56	0.69	0.022	0.027	
b1	0.77	0.90	0.030	0.035	
b2	5.23	5.43	0.206	0.214	
b3		1.05	0.000	0.041	
С	0.46	0.59	0.018	0.023	
c1	0.46	0.59	0.018	0.023	
D	6.00	6.20	0.236	0.244	
D1	5.20		0.205		
Е	6.50	6.70	0.256	0.264	
E1	4.60	5.00	0.181		
e	2.24	2.34	0.088	0.092	
e1	4.47	4.67	0.176	0.184	
Н	16.18	16.78	0.637	0.661	
L	9.00	9.60	0.354	0.378	
L1	0.95	1.35	0.037	0.053	
L2	0.90	1.25	0.035	0.049	



## NCE65T540I, NCE65T540K

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